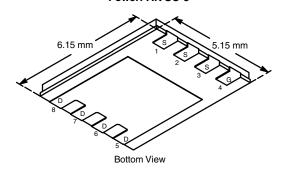
P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
-40	0.0092 at V _{GS} = -10 V	-18.6			
	0.0140 at V _{GS} = -4.5 V	-15			

PowerPAK SO-8

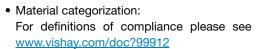


Ordering Information: Si7463DP-T1-E3 (Lead (Pb)-free)

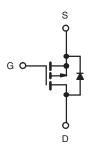
Si7463DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET® Power MOSFETs
- New low thermal resistance PowerPAK® package with low 1.07 mm profile







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, ui	nless otherwis	e noted)			
PARAMETER	SYMBOL	10 s	STEADY STATE	UNIT		
Drain-Source Voltage		V _{DS}	-40		V	
Gate-Source Voltage	V_{GS}	± 20		V		
Continuous Drain Current (T, = 150 °C)a	T _A = 25 °C	- I _D	-18.6	-11	٨	
Continuous Drain Current (1) = 150 °C) ^{cc}	T _A = 70 °C		-15	-8.9		
Pulsed Drain Current		I _{DM}	-60		А	
Continuous Source Current (Diode Conduction	I _S	-4.5	-1.6			
Maximum Power Dissipationa	T _A = 25 °C	Б	5.4	1.9	W	
Maximum Fower Dissipations	T _A = 70 °C	P_{D}	3.4	1.2	VV	
Operating Junction and Storage Temperature	T _J , T _{stg}	-55 to 150		°C		
Soldering Recommendations (Peak Temperature)b, c			2	60	C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	18	23		
	Steady State		52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1	1.3]	

Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. See solder profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



Vishay Siliconix

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	-1	-	-3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zoro Cata Valtaga Prain Current	_	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$	-	-	-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-40	-	-	Α	
Drain-Source On-State Resistancea	J	$V_{GS} = -10 \text{ V}, I_D = -18.6 \text{ A}$	-	0.0075	0.0092	Ω	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$	-	0.0110	0.0140		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -15 \text{ V}, I_D = -18.6 \text{ A}$	-	50	-	S	
Diode Forward Voltage ^a	V _{SD}	I _S = -4.5 A, V _{GS} = 0 V	_	-0.8	-1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g		-	121	140		
Gate-Source Charge	Q_{gs}	V_{DS} = -20 V, V_{GS} = -10 V, I_D = -18.6 A	-	19.2	-	nC	
Gate-Drain Charge	Q_{gd}		-	30.3	-		
Gate Resistance	R_g		-	2.7	-	Ω	
Turn-On Delay Time	t _{d(on)}		-	20	30		
Rise Time	t _r	V_{DD} = -20 V, R_L = 20 Ω	-	25	40		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1$ A, $V_{GEN} = -10$ V, $R_g = 6$ Ω	-	200	300	ns	
Fall Time	t _f		-	100	150		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -4.5 A, dI/dt = 100 A/μs	-	45	70		

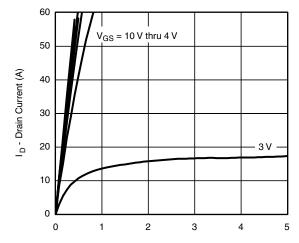
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

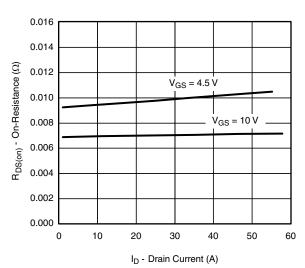


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

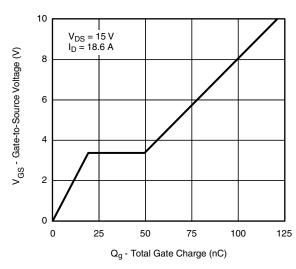


V_{DS} - Drain-to-Source Voltage (V)

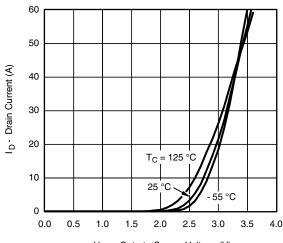
Output Characteristics



On-Resistance vs. Drain Current

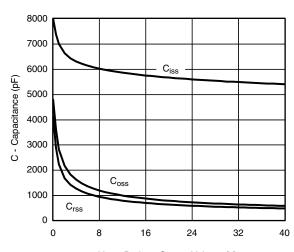


Gate Charge



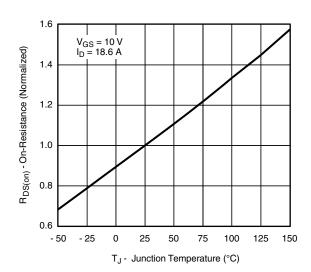
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V)

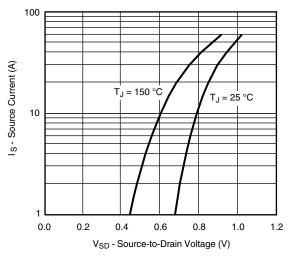
Capacitance

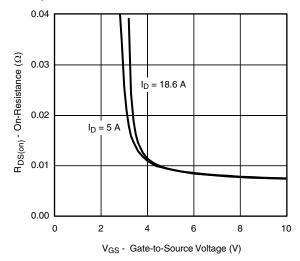


On-Resistance vs. Junction Temperature



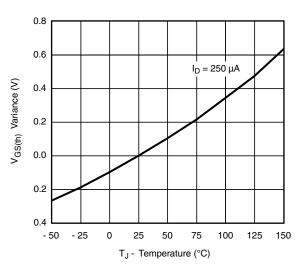
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

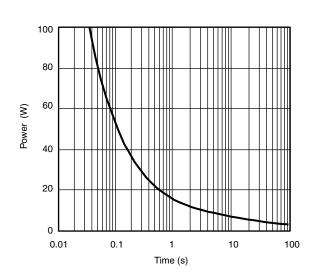




Source-Drain Diode Forward Voltage

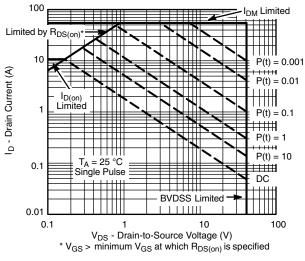
On-Resistance vs. Gate-to-Source Voltage





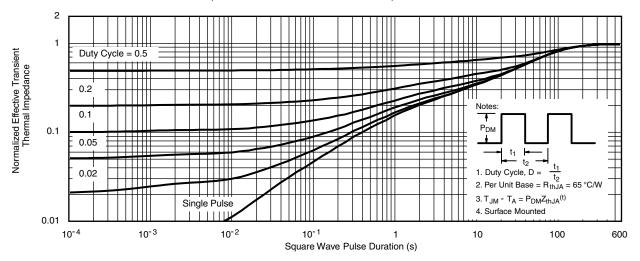
Threshold Voltage

Single Pulse Power, Junction-to-Ambient

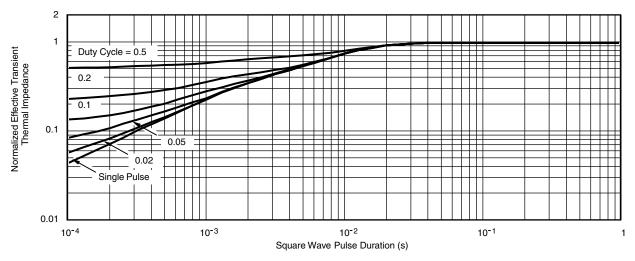




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



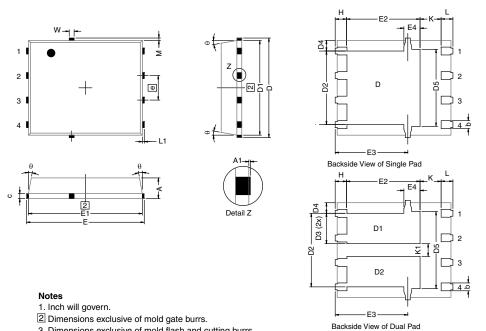
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72440.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)



3. Dimensions exclusive of mold flash and cutting burrs.								
DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
A	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
	4.00	4.00	F 00	0.400	0.400	0.407		

Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ. 0.023 typ.					
E4 (for other product)		0.75 typ.		0.030 typ.			
е		1.27 BSC		0.050 BSC			
K (for AL product)		1.45 typ.		0.057 typ.			
K (for other product)		1.27 typ.		0.050 typ.			
K1	0.56	-	=	0.022	-	=	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
M	0.125 typ.			0.005 typ.			
ECN: C13-0702-Rev. K, 20)-May-13			•			

Revison: 20-May-13 Document Number: 71655



RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Revision: 02-Oct-12 Document Number: 91000